

# DMA Controller (DMAC) For An MA31750 System

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The MA31753 Direct Memory Access Controller (DMAC) is a peripheral interface circuit design primarily for use with the MA31750 microprocessor. Each DMAC provides up to four independant, prioritised channels each of which can perform DMA transfers between memory and/or I/O devices using the MA31750 bus. Each channel has its own programmable internal priority and can be masked under program control. Further, individual channels have their own associated status and control words enabling an individual channel to be reprogrammed without disturbing transfers which may be taking place on other channels. Three basic transfer modes are available:

Direct Memory to I/O peripheral transfers,

Direct I/O to Memory transfers,

Memory to Memory transfers,

I/O to I/O transfers.

The MA31753 interfaces directly to the MA31750 bus, directly supporting on chip parity generation and supporting expanded memory via an MA31751 MMU with either 1 MWord (1750A mode) or 16MWords (1750B mode) of logical memory.

The MA31753 uses System memory to hold address and count information for each transfer. Once this information has been prepared by the processor the DMAC can conduct a number of transfers without further processor intervention.

# FEATURES

- Radiation Hard CMOS SOS Technology
- Four Independant DMA Channels
- MIL-STD-1750A or B Operation in an MA31750 System
- Capable of Processor Independant Table Driven Operation
- Memory to Memory, I/O to Memory, Memory to I/O and I/O to I/O Transfers Supported
- Masking of Individual Channel DMA Requests
- Simple MA31750 Bus Interface
- Single Word, Double Word or Multi-Word Transfers for each of the DMA Channels
- Cascade Interface Allows for Channel Expansion
- Programmable Channel Priority
- Parity Checking Available



Figure 1: Pin Connections - Top View

# **1.0 GENERAL DESCRIPTION**

The MA31753 DMA controller has 4 channels from which independant transfers can be executed. These channels have programmable priorities and can be masked. They can also be enabled and disabled under software control.

The data can be transferred in several modes - single word mode, double word mode and burst mode. It can be transferred to and from both incrementing and decrementing memory and IO addressing space. The single and double word modes transfer data in 1 or 2 bus cycles when the simple handshaking mechanism is enabled.

If more than 4 channels are required, several DMA controllers can be cascaded together to give channel expansion.

Once a channel has requested a transfer, and the bus arbiter has granted bus control to the DMA, then the DMA issues an acknowledge signal to the channel to be serviced. It also pulses read or write strobes which can be gated with the channel acknowledge signal to provide read and write strobes for the requesting hardware.

DMA instructions can be programmed into memory on the DMA. The transfers defined by these instructions can be executed in sequence if they are "chained together". In this way, DMA transfers can take place continuously with data that is held in seperate memory areas.

There is software access to all internal registers. These registers have parity protection. By setting certain bits in registers, requests can be initiated for area to area transfers on channels 0 and 1. Interrupts for each channel can also be issued.

# 2.0 INITIALISATION

After RESETN has been removed the DMA is automatically initiated to be disabled with odd parity, the channel priority order is 0, 1, 2, 3, C (C is the cascaded input) and all channels are masked. At this point, before the DMA is used further, the DMA instructions should be programmed into the DMA internal RAM. Once all the instructions needed are in place, the common features (ie. features that apply to all channels) on the DMA can be programmed. These features should be initialised to the users requirements.

The bus parity may be changed immediately after RESETN goes inactive when the MA31750 reads the configuration word ie. When the DMA detects the XIO address 0x8410, it snoops the data bus and latches the parity bit into an internal copy. This internal copy can later be changed by writing to the DMA Mode / Status register.

The DMA enable / disable follows the DMAE input - when this input is high, the DMA device is enabled. When DMAE is low, the DMA is disabled.

The channel priority and masking can be changed by writing to the DMA Mode / Status register.

Once the common characteristics of the DMA have been set up, the DMA individual channels can be programmed. Each channel has a mode register that should be programmed with an instruction number as that channel is activated (by writing the mode word).



Figure 2: Block Diagram Representing the DMA Controller

# **3.0 DMA FUNCTIONALITY**

Figure 2 shows a block diagram representing the structure of the DMA controller. This figure also shows how the DMA interfaces with the rest of the system.

Each DMA channel has 6 possible modes that it can operate in. These are as follows:

# 3.1 IDLE MODE

The channel goes into IDLE mode after an active hardware reset or after resetting the status flags. When in IDLE mode, the channel goes into PEND\_CHAIN mode when activated by writing the Mode register. No parity check is done on this register write.

### 3.2 PEND\_CHAIN MODE

Once the channel has been activated, it goes from IDLE to PEND\_CHAIN mode. In this mode, the first instruction is read (all 8 words). If a parity error is detected, the channel goes to the ERROR mode. If the read is successful, the channel will stay in the PEND\_CHAIN mode until either an active request is received or the Channel Request Pending bit is set in the Channel Status Register. At this time, the channel progresses to the PEND\_REQ mode.

### 3.3 PEND\_REQ MODE

In this mode, the Mode / Link word is checked to make sure it doesn't de-activate the channel (sending the device back to IDLE mode). If the channel remains active, the device sits in PEND\_REQ mode until the system bus arbiter grants the DMA bus control. Once this occurs, the transfer commences and the DMA enters TRANSFER mode.

## 3.4 TRANSFER MODE

If at any time during the transfer an error occurs, the channel is set into ERROR mode. If the transfers are clean of errors, then the behaviour of the device is dependant on the type of transfer mode that was programmed by the currently executing instruction.

#### 3.4.1 Single/Double Word and External Area to Area Mode

Within these modes, the DMA executes each data transfer seperately, ie. between each single / double word transfer, the request is removed. The DMA goes back into PEND\_REQ mode after each transfer and waits for the next request to be granted.

#### 3.4.2 Burst Area to Area Mode

With this type of transfer, the DMA transfers data whilst the bus control is granted. The channel request signal remains active. When control is removed by the arbiter, the device sits in the PEND\_TRANS mode until re-granted. If the burst mode is area to area with interval timing, then between each transfer, the channel has to count the interval.

Once a transfer has completed, the channel either sets the EOT bit and sits waiting for this to be reset before it goes back into INIT mode, or the instruction is chained and the channel jumps back to the PEND\_CHAIN mode where it can read the next instruction details for the next transfer. If during any transfer mode, the channel is de-activated, the channel goes back to INIT mode. If at any time, an error is detected, the device goes into ERROR mode.

### 3.5 ERROR MODE

This mode is entered from the PEND\_CHAIN mode if a parity error is detected during the instruction register reads. The error mode can also be entered from theTRANSFER mode. This can happen if PEN, MPROEN or EXADEN are activated by trying to access one of the data transfer addreses. An interrupt is generated in this mode. The only way to leave this mode is to reset all the error flags.

### 3.6 WORD TRANSFER MODES

It is possible to run each channel in single, double, and burst mode transfers.

### 3.6.1 Single Word Transfer

In single word transfer mode, the generation of each request on a channel causes the DMA controller to issue an external request that lasts for one bus cycle. The request is deactivated before the end of the bus cycle to allow other users to aquire bus control. If the transfer is to or from a device needing longer than one machine cycle (2 CLK cycles) then the cycle can be extended using handshaking of the DMA request and acknowledge lines.

#### 3.6.2 Double Word Transfer

In double word mode, each request on a channel causes the DMA controller to request bus control for 2 machine cycles to allow the transfer of 2 16-bit data words. The data is transferred to consecutive addresses and the bus is locked between each word transfer to protect the transfer. The most significant word to be transferred has the lowest address and is transferred first (following the 1750 standard). The request is de-activated before the end of the second bus cycle to allow other bus users to take control. If an extended cycle is needed, the handshaking mechanism doesn't word in this mode and the RDYN signal must be kept high for as long as required.

### 3.6.3 Burst Mode

In burst mode, one request to the channel causes the DMA to request bus control for a complete block of data to be transferred. The DMA de-asserts the request line on the last transfer cycle to allow other users to take bus control. Consequently, if the transfers are chained together, the CPU may be able to get bus control between 2 blocks of data transfer. If extended bus cycles are needed, the RDYN mechanism can be used (handshaking does not work in this mode).

#### 3.6.4 Area to Area Mode

In area to area mode, the transfers can be initiated either by external requests or internally generated by the DMA depending on the value in the interval timer (the software generated requests controlleed by the interval timer can only be used on channels 0 and 1). Each request makes the DMA request bus control for 2 machine cycles. The transfers can take place to and from IO and / or memory depending on how the instruction programs the channel. The DMA de-asserts the request during the second cycle unless the instruction has programmed the channel to do "Continuous Internal Request". In this case, the request is only de-asserted on the last cycle of the block. If extended bus cycles are needed, the RDYN mechanism must be used as the handshaking does not work in this mode.

### 3.6.5 Instruction Chaining

When the first request is received on a channel, it accesses the DMA instruction number that is programmed in the mode word. This instruction is read from internal DMA RAM. This takes 16 CLK cycles (as there are 8 16-bit word in the instruction). Bus control is not needed during these internal RAM accesses. At the end of the 16 CLK cycles, the channel has all the transfer information it needs and can begin to transfer whenever it is granted bus control. Once the transfer has completed, the channel checks that it is in chaining mode and that the instruction is a chained instruction. If so, then as the first instruction completes, the DMA can access the next instruction (again taking 16 CLK cycles) and the transfers can continue as bus control is granted.

#### 3.6.6 Handshaking Mechanism

There is a handshaking mechanism available when using single-word transfer mode. It works as follows:

For a memory read cycle:

- 1: The IO port issues a request.
- 2: The DMA requests and is granted bus control. The DMA starts a memory read cycle. As well as the usual control and strobes, the DMA also asserts the DACKN low for the channel that it is responding to. The DACKN signal acts as an IO port select.
- 3: Once valid data is available on the data bus ie. RDYN has gone low, the DMA asserts AKWRN low. The IO port uses AKWRN as a write strobe.
- 4: The IO port acknowledges the completed data read by deasserting DREQN.
- 5: When the DMA sees DREQN has gone high, it de-asserts DACKN. At this time, the data is still valid and the IO port may latch the data on AKWRN rising or any time in between.
- 6: The DMA completes the cycle by de-asserting strobes etc.
- 7: The wait state generator finally de-asserts RDYN.

For a memory write cycle:

- 1: The IO port issues a request.
- 2: The DMA aquires bus control and starts a memory write cycle, also asserting DACKN for the relevant channel.
- 3: The data bus is driven by the IO port. Valid data is available when the IO port de-asserts DREQN. (DACKN is still asserted so valid data must still be driven on the bus).
- 4: When the DMA senses DREQN high, it writes the valid data from the IO port into memory.
- 5: The memory write is completed when RDYN goes low.
- 6: The DMA de-asserts DACKN and hence the IO port stops driving the data bus.

If DREQN is de-asserted 2 or more CLK cycles before AKRDN or AKWRN are asserted, then the handshaking protocol does not apply and the cycle will simply use the RDYN signal going low to terminate the cycle (both AKRDN and AKWRN will rise as AS falls at the end of the cycle).

### **3.7 INTERRUPT GENERATION**

The DMA shall generate an interrupt on the occurrance of any of the following:

- A channel has reached an "End of Transfer" condition and the EOT bit has been set in the channel status register.
- A channel has been stopped because
  - a) a bus timeout has occurred. (ie. either DREQN (handshake mode) or RDYN is asserted for more than 256 CLK cycles)
  - b) an internal parity error was detected when reading a DMA register with parity.
  - c) An odd block length was programmed in double word mode.

The DMA will stop but will not generate an interrupt if EXADEN, MPROEN or PEN are active at the end of an external cycle.

If a parity error is detected whilst writing to the DMA registers, the erroneous write will not let transfers commence. The DMA generates interrupts by pulsing INTRN low. If more than one error occurs simultaneously, INTRN is only pulsed once. The interrupt can only be generated when the DMA is in the ERROR mode. The only way to get out of this mode is to reset all error flags.

#### **3.8 CHANNEL MASKING AND STOPPING**

Each channel can be masked individually by setting the relevant bit in the DMA Mode / Status register. If the channel is masked, only external requests are gated out - software requests are still serviced.

Each channel can be stopped by de-activating the channel by writing the Channel Mode register. This register can only be written whilst in PEND\_CHAIN mode or awaiting bus control. Once the channel is de-activated, it returns to the IDLE mode.

#### **3.9 PARITY CHECKING**

Parity checks are done when DMA registers are being written and when they are being accessed ie. when the instructions are being read.

### 3.10 SOFTWARE PROGRAMMING

DMA requests can be generated in software by writing the CRQP bit in the Channel Status register. If the channel is active, the DMA will then request bus control. If the DREQN signal on that channel is not active, the DMA finishes the cycle as soon as the memory is ready. There is no handshaking with the IO port. DACKN is deasserted when the memory is ready. If DREQN is asserted but is masked, the handshaking is active and operates normally.

Interrupts can be generated in software by setting either a channel EOT flag or any error flag. This can only be done when the DMA is in PEND\_CHAIN mode. If an error flag is set, the device goes straight to ERROR mode. If the EOT flag is set, the device looks as if it has completed the transfer. It will then just sit and wait for the EOT flag to be cleared before entering IDLE mode. If both flags are set simultaneously, the device remains in PEND\_CHAIN mode. Setting an error flag when EOT is set resets EOT and the device goes to ERROR mode. Setting EOT when an error flag is set clears the error and the DMA sits in the finish transfer mode.

# 3.11 CASCADING DMA CONTROLLERS

DMA controllers are cascaded in series. For each DMA added, an extra 4 channels become available. To cascade the devices, the strobes, control signals and address and data busses are connected in parallel. Of the bus arbitration signals, LOCKN and GRANTN should be connected in parallel and REQINN, GEINN and GEOUTN should be daisy-chained. INTRN and PEN can either be ORed together with external glue logic or input to seperate CPU interrupts. Figure 3 shows the cascade connections.



Figure 3: Cascading DMA Controllers

# **4.0 DETAILED REGISTER DESCRIPTION**

The internal registers on the DMA controller can be located in either memory or IO addressing space. 32 words are control registers and 480 words are the DMA instruction registers.

The address lines A[7:15] are used to decode the registers. (A[0:6] are decoded to generate CSN low ie. the user can place the DMA on the address map.)

A[7:15]	Register Content	Parity
0	DMA Instruction	Yes
		-
1DF	DMA Instruction	Yes
1E0	Channel 0 Mode	No
1E1	Channel 0 Remaining words	No
1E2	Channel 0 Area 1 current address	No
1E3	Channel 0 Area 1 current PB/AS/PS	No
1E4	Channel 0 Area 2 current address	No
1E5	Channel 0 Area 2 current PB/AS/PS	No
1E6	Channel 0 Status	No
1E7	DMA Mode / Status 1	No
1E8	Channel 1 Mode	No
1E9	Channel 1 Remaining words	No
1EA	Channel 1 Area 1 current address	No
1EB	Channel 1 Area 1 current PB/AS/PS	No
1EC	Channel 1 Area 2 current address	No
1ED	Channel 1 Area 2 current PB/AS/PS	No
1EE	Channel 1 Status	No
1EF	RESERVED	No
1F0	Channel 2 Mode	No
1F1	Channel 2 Remaining words	No
1F2	Channel 2 Area 1 current address	No
1F3	Channel 2 Area 1 current PB/AS/PS	No
1F4	Channel 2 Area 2 current address	No
1F5	Channel 2 Area 2 current PB/AS/PS	No
1F6	Channel 2 Status	No
1F7	RESERVED	No
1F8	Channel 3 Mode	No
1F9	Channel 3 Remaining words	No
1FA	Channel 3 Area 1 current address	No
1FB	Channel 3 Area 1 current PB/AS/PS	No
1FC	Channel 3 Area 2 current address	No
1FD	Channel 3 Area 2 current PB/AS/PS	No
1FE	Channel 3 Status	No
1FF	RESERVED	No

# 4.1 MODE REGISTERS

CA	read 0:	channel not active
	write 0:	stop channel
	read 1:	channel active
	write 1:	start channel
	This bit	will be set low at an error or EOT condition

Mode	000:	Single Word
	001:	Double Word
	010:	Burst Mode
	011:	Not used (channel not started)
	100:	Area to Area, Memory to Memory
	101:	Area to Area, Memory to IO
	110:	Area to Area, IO to Memory
	111:	Area to Area, IO to IO
A1M	Area 1 M	Лоde
	For sing	le, double and burst modes

- 00: Read from memory, incrementing address
- 01: Read from memory, decrementing address
- 10: Write to memory, incrementing address
- 11: Write to memory, decrementing address

Area to area mode

- 00: Area 1 address constant
- 01: Area 1 address incrementing
- 10: Area 1 address decrementing
- 11: Area 1 address constant
- A2M Area 2 Mode (only used in area to area mode)
  - 00: Area 2 address constant
  - 01: Area 2 address incrementing
  - 10: Area 2 address decrementing
  - 11: Area 2 address constant
- SEOT 0: Signal 'End of Transfer' at end of current block only of C=0
  - 1: Always signal 'End of Transfer' at end of current block.

C read 0: Perform no chaining

- read 1: Perform chaining using the value of "next Instruction" field as pointer
  - write 0: Perform no chaining even if defined by current DMA instruction
  - write 1: Perform chaining as defined by current instruction

Next These 6 bits point to one of the 60 DMA instructions ie. Inst the next instruction to be executed.

If the number is 3C, 3D, 3E or 3F, then the transfer will stop with the current block (ie. no chaining)

Mode Register

CA	Mode		A	1M	A	2M	SEOT	С	N	ext Ins	structic	n		
														I
D0										-			D15	

# **4.2 REMAINING WORD REGISTERS**



Read access only. These 16-bit registers store the number of words left to be transferred for each area.

# **4.3 CURRENT ADDRESS REGISTERS**



Read access only. These 16-bit registers store the addresses of the current words to be transferred to / from the area represented by the register.

### 4.4 CURRENT PB / PS / AS REGISTER

OIN		PB0		PB3	PS0		PS3	AS0		AS3	
D0										D15	,

Read access only. These 16-bit registers store the current page bank, address and process state information for each area. When the areas have been selected within the IO space, PB, PS and AS shall be zero.

#### **4.5 STATUS REGISTERS**

СА	EOT	CRQP		IPE	BLE	BIE	CLE		1				Inte	rval	I						
D0															D15	j					
CA		0: Cl 1: Cl This b	hanne hanne bit is a	el not el activ autom	active ve atical	e ly set	to ze	ro at a	an err	or or	EOT	condit	tion.								
EOT		0: CI 1: CI	hanne hanne	el EO <sup>-</sup> el EO <sup>-</sup>	Г not Г read	reach ched.	ed														
CRQI	Þ	0: No 1: Cl Itisn	o cha hanne ot pos	nnel [ el DM/ ssible	DMA r A requ to res	eque uest p set thi	st per bendir s bit a	nding. ng. as Ion	g as a	a DR	EQN I	ine is	assei	ted.							
IPE		0: No 1: In	o inte ternal	rnal p parit <u></u>	arity e y erro	error r whe	n rea	ding [	DMA	regis	ter wit	h pari	ty.								
BLE		0: No 1: Bl	o erro ock le	r ength	error	(odd	block	lengt	h in d	ouble	e word	l mode	e)								
BIE		0: No 1: Bu	o erro us inte	r erface	time	out er	ror (c	ause	d eith	er by	not de	easse	rting I	DREG	QN in	handsh	ake m	iode c	or by a l	ous time	eout)
CLE		0: No 1: C	o erro PU lai	r tched	error	(eithe	er MP	ROEI	N, EX	ADE	N or F	PEN)									
Interv	al	The ir	nterva	ıl, in C	CLK c	vcles,	betw	een e	each [	DMA	reque	st ger	nerate	d duri	ing ai	ea to a	rea tra	ansfer	s.		

# 4.6 DMA MODE / STATUS 1

М3	M2	M1	1 M0 EOT3 EOT2 EOT1 EOT0 ERR A/B BP DMAE Priority										
D0 Mn	0 1	C C	hann hann	el n no el n m	ot mas asked	sked 1							D15
EOTr	n 0: 1: R	: Cl : Cl ead a	hann hann cces	el n "E el n "E s only.	nd of nd of Valu	Tran: Tran: e can	sfer" r sfer" r be ch	not re each nange	achec ed ed by v	l writing	g the	chann	el status register.
ERR	0 1 R	: No Ei ead a	o erro ror d ccess	or dete etecte s only.	ected ed in o . Valu	ne or e can	more be ch	of th	e cha d by v	nnels writing	g the	chann	el status register.
A / B	0 1	: 17 : 17	750A mode 750B mode										
BP	0 1	: E\ : O	/en b dd bu	us pa ıs pari	rity us ity use	ed ed							
DMA	E 0 1 R	: Di : Di ead a	DMA requests disabled DMA requests enabled access only										
Pri	00 00 00 10 10 10 11	00: C 01: C 10: C 11: C 00: C 01: C 10: C 11: C	3: Channel priority 0, 1, 2, 3, C         1: Channel priority 1, 2, 3, 0, C $3$ : Channel priority 2, 3, 0, 1, C         1: Channel priority 3, 0, 1, 2, C $3$ : Channel priority C, 0, 1, 2, 3         1: Channel priority C, 1, 2, 3, 0         2: Channel priority C, 3, 0, 1, 2         3: Channel priority C, 3, 0, 1         1: Channel priority C, 2, 3, 0, 1         1: Channel priority C, 3, 0, 1, 2										

# **5.0 DMA INSTRUCTIONS**

60 DMA instructions are present in the memory or IO space between A[7:15] = 0 and A[7:15] = 1DF. Each DMA instruction comprises of 8 16-bit words. The base address for each instruction is 8<sup>\*</sup>n where n is the instruction number. The instructions are structured as below:

Word number	Content
0	Mode/Link word
1	Block length
2	Area 1 base address
3	Area 1 PB, PS and AS
4	Area 2 base address
5	Area 2 PB, PS and AS
6	Transfer interval
7	Not used

Words 4, 5 and 6 are used only during area to area mode transfers. Word 6 can only be used for channels 0 and 1.

# 5.1 MODE / LINK WORD

	Mode		A1	М	A2	2M	SEOT	С		N	ext Ins	truction	
D0 Mode	000: 001: 010: 011: 100: 101: 110: 111:	Singl Doub Burst not u Area Area Area	le wo ble w t moo sed to A to A to A to A	ord ord de (chan rea, N rea, I rea, I rea, I	nel no Iemo Iemo O to N O to I	ot sta ry to l ry to l /lemo O	rted) Memo IO ry	ry					D1:
A1M	Area 1 I For sing 00: 01: 10: 11:	Mode Ile, do Read Read Write Write	uble d fror d fror e to n e to n	and b n mer n mer nemor nemor	ourst r nory, nory, ry, inc ry, de	node incre decre reme creme	s mentii ement enting enting	ng ad ing ad addre addr	dress ddres ess ess	S			
	Area to 00: 01: 10: 11:	area n Area Area Area Area Area	node 1 ad 1 ad 1 ad 1 ad	e Idress Idress Idress Idress	s cons s incre s decr s cons	tant ement emer stant	ting Iting						
A2M	Area 2 I 00: 01: 10: 11:	Vode Area Area Area Area	(only 2 ad 2 ad 2 ad 2 ad	used Idress Idress Idress Idress	l in are cons incre decr cons	ea to tant ement emer tant	area i ting iting	mode	)				
SEOT	0: 1:	Signa Alwa	al 'Er ys si	nd of <sup>-</sup> gnal '	Trans End o	fer' a f Tra	t end o nsfer'	of cur at en	rent b d of c	olock urren	only o It bloc	f C=0 k.	
С	read 0: read 1: write 0:	Perfo Perfo Perfo	orm r orm c orm n	io cha hainii o cha	aining ng usi iining	ng th even	e valu if defi	ie of " ned b	next	Instru rent [	iction" DMA ii	field as	s pointer on

- write 1: Perform chaining as defined by current instruction
- Next These 6 bits give the number of the next instruction to be executed. If the number is 3C, 3D, 3E or 3F, then the DMA transfers will stop with the current block.

# 5.2 BLOCK LENGTH



This readable and writable 16-bit word gives the number of words to be transferred for the current DMA block.

# 5.3 AREA 1 AND 2 BASE ADDRESSES



These registers hold the addresses of the first word of memory or IO to be transferred (ie. when the channel is decrementing the address, this register holds the highest address to be transferred.)

# 5.4 AREA 1 AND 2 PB, PS AND AS

OIN		PB0		PB3	PS0		PS3	AS0		AS3
D0										D15

These readable and writable registers store the Page Bank, Processor and Address State information to be used when accessing areas 1 and 2. When areas are defined within IO space, PB, PS and AS are set to zero.

### **5.5 TRANSFER INTERVAL**

							Inte	rval	
D0									D15

This readable and writable register gives the number of CLK cycles between each DMA request generated during area to area transfers. The number entered as the interval value corresponds to a clock cycle interval increasing by 32 as follows:

0	=>	<ul> <li>(externally triggered DMA requests)</li> </ul>
1	=>	0 (continuous DMA requests until the block is completed.
2	=>	32
3	=>	64
4	=>	96
14	=>	416
15	=>	448

This function is valid only for transfers on channels 0 and 1. Channels 2 and 3 work ony only on externally triggered requests.

### **5.6 CONFIGURATION WORD**

The DMA controller snoops the system address bus for the XIO address 0x8410. When this appears, the DMA stores the data bus (qualified by DSN low) in an internal copy of the CPU configuration word.

# **6.0 PIN DESCRIPTIONS**

A[0:15]		A [0] is the most significant hit of this logical address hus. This hus is an input during cycles not assigned to the
A[0.13]	1/0	DMA and is driven during DMA cycles.
PB[0:3]	0	Used in 1750B mode only, this bus provides DMA page bank information which addresses up to 8M of memory. The bus is tri-stated during cycles not assigned to the DMA.
AS[0:3]	0	This bus indicates the current address state of the DMA controller. It is tri-stated during cycles not assigned to the DMA.
PS[0:3]	0	This bus indicates the current process state of the DMA controller. It is tri-stated during cycles not assigned to the DMA.
D[0:16]	1/0	DIOI is the most significant bit of the data bus. During DMA cycles, data is input on read cycles and output on write
-[]		cycles. D[16] is the parity bit. Odd or even parity is set in the configuration word. Parity is not used during DMA writes to memory.
CLK		Input clock signal
RESETN		This active low signal resets the DMA.
CSN		When low, access to read and write the DMA internal registers is enabled.
AS	1/0	AS high indicates the presence of a valid address on the address bus. This signal is an input on cycles not assigned to the DMA.
DSN	1/0	When low, data strobe indicates the presence of data on the data bus. This signal is an input on cycles not assigned to the DMA.
MION	I/O	If high, this signal indicates that the current cycle is accessing memory space. If low, the current cycle is accessing IO space. Is an input during cycles not assigned to the DMA.
RDWN	1/0	During DMA cycles, this signal goes high to indicate read cycles and low to indicate write cycles. It is an input during non-DMA cycles.
OIN	0	During DMA cycles, this signal goes high to indicate operand cycles and low to indicate instruction cycles. It is tri- stated during non-DMA cycles.
RDN	0	This active low read strobe is tri-stated on non-DMA cycles.
WRN	0	This active low write strobe is tri-stated on non-DMA cycles.
RDYN	I/O	This signal goes active low to indicate that the current bus cycles can be terminated. It is an output on cycles addressing the DMA internal registers, input on cycles controlled by the DMA and is tri-stated during all other cycles.
LOCKN	0	This signal is driven low during the first bus cycle of a double word transfer. It should be used by the bus arbiter to 'lock' bus control to the DMA. It is tri-stated during cycles not assigned to the DMA.
REQN	0	Always driven, this signal goes low to indicate that the DMA requests the bus.
GRANTN	I	Sampled by the DMA on negative CLK edges, this signal goes low to indicate that the DMA has bus control.
DMAKN	0	This output is driven active low by the DMA when it has bus control. It is tri-stated on cycles not assigned to the
DONEN	0	DMA. This signal is pulsed low for one CLK cycle when any of the four DMA channels reaches an 'end of transfer'
REQINN	Ι	Sampled by the DMA on negative CLK edges, a low on this input indicates that a cascaded, lower priority DMA is
GEINN	I	This active low signal is used to qualify the GRANTN signal for cascaded DMA devices. This signal should be tied
GEOUTN	0	low on the first DMA of the chain. This active low output indicates that a lower priority DMA will be granted the bus when the GRANTN signal is
		asserted low from the arbiter. It is used to cascade DMA devices by connecting to the GEINN pin of the next DMA.
	0	This active low interrupt request signal pulses low when an 'end of transfer' or an internal error condition are detected.
PEN		The DMA samples PEN on AS falling. If an error condition is sampled, the transfer on the DMA channel is stopped and the CLE bit is set in the Channel Status Register.
DMAE	Ι	An active high input to indicate that the DMA is enabled. If this input is low, internal requests are supressed, there is no response to external requests and REQINN is gated out internally.
DPARN	1	A low on this signal resets and disables checking of the parity bit (D[16])
DTON	1	A low on this signal resets and disables the bus fault timeout circuitry.
MPROEN	I	This input is sampled on AS falling when the DMA has bus control. If an active low is sampled, the transfer stops on the channel concerned and the CAE (addressing error) bit is set in the channel status register. An interrupt may be generated.
EXADEN	Ι	This input is sampled on AS falling when the DMA has bus control. If an active low is sampled, the transfer stops on the channel concerned and the CAE (addressing error) bit is set in the channel status register. An interrupt may be generated.
DREQN[0:3]	Ι	Sampled by the DMA on negative CLK edges, a low on this bus initiates a DMA transfer providing the corresponding channel is correctly set up and is not masked. When the pin is pulled high, the ongoing bus cycle will terminate.
DACKN[0:3]	0	During a transfer, the DMA drives the relevant channel acknowledge low to indicate that the DMA is ready for the data. The low to high transition at the end of the cycle is initiated by the condition DREQN high and RDYN low.
SEC/FIRSTN	0	A high indicates that the first word in a transfer is occuring. A low indicates that the second word in a double word transfer is occuring.
AKRDN	0	This active low strobe indicates that the DMA is driving the data bus.
AKWRN	Ō	This active low strobe indicates that the DMA is inputting data from the data bus.

# TIMING DIAGRAMS



Figure 4: Single Cycle With Handshake, Memory Read



Figure 5: Single Cycle With Handshake, Memory Write

CLK DREQN DACKN	
AKRDN	
DONEN	
SEC/FIRSTN	
REQN	
GRANTN A [0:15] MION RDWN OIN DMAKN AS DSN WRN RDN LOCKN RDYN	

Figure 6: Single Cycle Without Handshake, Memory Read

CLK	
DREQN	
DACKN	
AKRDN	
AKWRN	
DONEN	
SEC/FIRSTN	
REQN	
GRANTN A [0:15] MION RDWN OIN DMAKN AS DSN RDN WRN	
LOCKN	
RDYN	

Figure 7: Single Cycle Without Handshake, Memory Write





Figure 8: Double Mode, Memory Read



Figure 9: Double Mode, Memory Write



Figure 10: Burst Mode 6 Words, Memory Read



Figure 11: Burst Mode 4 Words, Memory Write (with interruption of the block)



Figure 12: DMA XIO read and write cycles



Figure 13: Cascade Mode



Figure 14: Miscellaneous Timings

No	Description	Min	Mox	Linita
1	Description DESETN actual to CLK folling	IVIIII	IVIAX	Units
	RESETN Setup to CLK failing		-	115
	RESETN hold aller CLK falling		-	ns
3	RESETIN pulse wath		-	ns
4	A[0:15] setup to CSN failing (DMA XIO)		-	ns
5	A[0.15] HOID AILER DSN HSING (DMA XIO)		-	ns
0	CSN setup to DSN failing (DMA XIO)		-	ns
	CSN noid after DSN rising (DIVIA XIO)		-	ns
8	MION, OIN, RDWN setup to AS rising (DMA XIO)		-	ns
9	MION, OIN, RDWN hold after AS failing (DMA XIO)		-	ns
10	RDN failing to D[0:16] driven (XIO read)			ns
11	RDN failing to D[0:16] Valid (XIO read)			ns
12	RDN rising to D[0:16] Invalid (XIO read)			ns
13	RDN rising to D[0:16] tri-state (XIO read)			ns
14	Digital setup to WRN rising (XIO write)		-	ns
15	D[U:16] hold after WRN rising (XIO write)		-	ns
16	CLK failing to RDYN valid (DMA XIO)			ns
1/	CSN rising to RDYN tri-state (DMA XIO)			ns
18	CSN falling to RDYN driven (DMA XIO)			ns
19	CLK rising to AS rising			ns
20	CLK falling to AS falling			ns
21	A[0:15], AS[0:3], PS[0:3], PB[0:3] valid to AS rising			ns
22	A[0:15], AS[0:3], PS[0:3], PB[0:3] valid after AS failing			ns
23	MION, OIN, RDWN valid to DSN falling			ns
24	MION, OIN, RDWN valid after DSN rising			ns
25	CLK falling to AKRDN, AKWRN valid			ns
26	CLK falling to DACKN[0:3] falling			ns
27	CLK falling to DACKN[0:3] rising			ns
28	CLK falling to DMAKN valid			ns
29	CLK falling to DONEN valid			ns
30	CLK falling to DSN, RDN, WRN valid			ns
31	CLK falling to GEOUTN valid			ns
32	CLK falling to INTRN valid			ns
33	INTRN pulse width			ns
34	CLK falling to LOCKN falling			ns
35	CLK falling to LOCKN rising			ns
36	CLK falling to SEC/FIRSTN valid			ns
37	CLK falling to REQN valid			ns
38	DREQN[0:3] setup to CLK falling		-	ns
39	DREQN[0:3] hold after CLK falling		-	ns
40	EXADEN, MPROEN, PEN setup to AS falling		-	ns
41	EXADEN, MPROEN, PEN hold after AS faling		-	ns
42	GRANTN setup to CLK falling		-	ns
43	GRANIN hold after CLK falling		-	ns
44	GEINN setup to CLK falling		-	ns
45	GEINN hold after CLK falling		-	ns
46	KDYN setup to CLK talling		-	ns
47	RDYN hold after CLK falling		-	ns
48	REQINN setup to CLK falling		-	ns
49	REQINN hold after CLK falling		-	ns
50	CLK rising to busses, strobes and control signals (note 1) tri-state			ns
51	CLK talling to busses, strobes and control signals (note 1) driven			ns
52	D[0:16] setup to AKRDN rising		-	ns
53	D[0:16] hold after AKRDN rising		-	ns
54	D[0:16] valid after AKWRN falling			ns
55	D[0:16] valid after AKWRN rising			ns
56	DPARN setup to CLK falling		-	ns
57	DPARN hold after CLK falling		-	ns
58	DTON setup to CLK falling		-	ns
59	DTON hold after CLK falling		-	ns
60	DMAE setup to CLK falling		-	ns
61	DMAE hold after CLK falling		-	ns

Mil-Std-883, Method 5005, Subgroups 9, 10, 11. TL = Low CLK period (ns), TH = High CLK period (ns). Test Conditions: Vdd =  $5.0V \pm 10\%$ , Temperature =  $-55^{\circ}$ C to  $125^{\circ}$ C, Vil = 0.0V, Vih = Vdd. Output loads: All test load 1 unless otherwise specified. Output Threshold: 50% Vdd (Load 1), Vss+1V, Vdd-1V (Load 2).

Note 1: A[0:15], AS[0:3], PS[0:3], PB[0:3], MION, OIN, RDWN, DMAKN, AS, DSN, RDN, WRN, LOCKN

Figure 15: Timing Parameters

# **RATING AND CHARACTERISTICS**

Parameter	Min.	Max.	Units
Supply voltage	-0.5	7	V
Input voltage	-0.3	VDD+0.3	V
Current through any I/O pin	-20	20	mA
Operating temperature	-55	125	°C
Storage temperature	-65	150	°C

Note: Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these conditions, or at any other condition above those indicated in the operations section of this specification, is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Figure 16: Absolute Maximum Ratings

Parameter	Min.	Max	Units
Clock Frequency (CLK)	0	16	MHz
Recommended Clock duty cycle	45	55	%

 $\label{eq:Vdd=5V\pm10\% over full operating temperature range Mil-Std-883, method 5005, subgroups 7, 8A, 8B$ 

Figure 17: Operating AC Electrical Characteristics

				Total dose radiation not exceeding 3x10 <sup>5</sup> Rad(Si)		
Symbol	Parameters	Conditions	Min	Тур	Max	Units
V <sub>DD</sub>	Supply voltage	-	4.5	5.0	5.5	V
VIH	Input high voltage	-	80% V <sub>DD</sub>	-	-	V
VIL	Input low voltage	-	-	-	20% V <sub>DD</sub>	V
VCKH	CLK input high voltage	-	V <sub>DD</sub> -0.5	-	-	V
VCKL	CLK input low voltage	-	-	-	V <sub>SS</sub> +0.5	V
VOH	Output high voltage	I <sub>OH</sub> =-3mA	V <sub>DD</sub> -0.5	-	-	V
V <sub>OL</sub>	Output low voltage	I <sub>OL</sub> =5mA	-	-	V <sub>SS</sub> +0.4	V
IН	Input high current (Note 1)	-	-	-	10	μA
١ <sub>١L</sub>	Input low current (Note 1)	-	-	-	-10	μA
I <sub>OZH</sub>	I/O tristate high current (Note 1)	-	-	-	50	μA
I <sub>OZL</sub>	I/O tristate low current (Note 1)	-	-	-	-50	μA
IDDYN	Dynamic supply current @ 16MHz	-	-	-	80	mA
I <sub>DDS</sub>	Static supply current	-	-	-	10	mA

Vdd=5V±10% over full operating temperature range

Mil-Std-883, method 5005, subgroups 1, 2, 3

Note 1: Guaranteed but not tested at low temperature (-55°C)

Figure 18: Operating DC Electrical Characteristics

Subgroup	Definition
1	Static characteristics specified in Figure 18 at +25°C
2	Static characteristics specified in Figure 18 at +125°C
3	Static characteristics specified in Figure 18 at -55°C
7	Functional characteristics specified in Figure 17 at +25°C
8A	Functional characteristics specified in Figure 17 at +125°C
8B	Functional characteristics specified in Figure 17 at -55°C
9	Switching characteristics specified in Figure 15 at +25°C
10	Switching characteristics specified in Figure 15 at +125°C
11	Switching characteristics specified in Figure 15 at -55°C

Figure 19: Definition of MIL-STD-883, Method 5005 Subgroups

# **PIN ASSIGNMENTS AND OUTLINES**



Figure 20: 84-Lead Flatpack - Package Style F



NOTE: All dimensions shown in inches

Figure 21: 84-Lead Flatpack - Package Style F



A1	B11	F9	K2
A2	C1	F10	K3
A3	C2	F11	K4
A4	C5	G1	K5
A5	C6	G2	K6
A6	C7	G3	K7
A7	C10	G9	K8
A8	C11	G10	K9
A9	D1	G11	K10
A10	D2	H1	K11
A11	D10	H2	L1
B1	D11	H10	L2
B2	E1	H11	L3
B3	E2	J1	L4
B4	E3	J2	L5
B5	E9	J5	L6
B6	E10	J6	L7
B7	E11	J7	L8
B8	F1	J10	L9
B9	F2	J11	L10
B10	F3	K1	L11

Figure 22: 84-Pin Grid Array - Package Style A



Figure 23: 84-Pin Grid Array - Package Style A

# **RADIATION TOLERANCE**

# **Total Dose Radiation Testing**

For product procured to total dose radiation levels, each wafer lot will be approved when all sample devices pass the total dose radiation test.

The sample devices will be subjected to the total dose radiation level (Cobalt-60 Source), defined by the ordering code, and must continue to meet the electrical parameters specified in the data sheet. Electrical tests, pre and post irradiation, will be read and recorded.

Dynex Semiconductor can provide radiation testing compliant with MIL STD 883 test method 1019, Ionizing Radiation (Total Dose).

Total Dose (Function to specification)*	3x10 <sup>5</sup> Rad(Si)
Transient Upset (Stored data loss)	1x10 <sup>11</sup> Rad(Si)/sec
Transient Upset (Survivability)	>1x10 <sup>12</sup> Rad(Si)/sec
Neutron Hardness (Function to specification)	>1x10 <sup>15</sup> n/cm <sup>2</sup>
Single Event Upset**	<1x10 <sup>-10</sup> Errors/bit day
Latch Up	Not possible

\* Other total dose radiation levels available on request

\*\* Worst case galactic cosmic ray upset - interplanetary/high altitude orbit

Figure 24: Radiation Hardness Parameters

# **ORDERING INFORMATION**





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Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

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